

DOCKET NO. EN995064BVUS4

D/#11 101/30/12

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: Papathomas et al.		Examiner: Berma	Examiner: Berman, S	
Serial	No.: 09/771,275)	Art Unit: 1711	TECHNICA PROCE
Filed:	01/26/01)		Marie Control
For:	LEAD PROTECTIVE COATING CON STRUCTURE THEREOF	CELL TO VO		
	nissioner for Patents ington D.C. 20231			*100

Sir:

This paper is being filed in response to the Office Action dated April 24, 2002.

Reconsideration and allowance are respectfully requested in view of the Amendments and Remarks below.

AMENDMENT

Please cancel claims 25 and 26. Pending Claims 18-24 and new Claim 27 are as follows, wherein Claims 13 and 23 are amended and Claim 27 is new.

In The Claims

13 (THRICE AMENDED) A method for encapsulating a solder joint between an integrated circuit thip and a substrate, comprising the steps of:

forming a composition that includes a photoinitiator, a dispersed filler, and a resin precursor, wherein the resin precursor substantially consists of a cyanate ester monomer, a

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In Re Application Of: Pap	oathomas et al.					
Serial No. 09/771,275	Filing Date 1/26/01	Examiner Berman, S.	Group Art Unit 1711			
JIL 2 6 MM COLO	VE COATING COMPOSITION	N, PROCESS AND STRUCTU	THEREOF			
TO THE ASSISTANT COMMISSIONER FOR PATENTS:						
Transmitted herewith is: Amendment			RECEIVED TOO TECHNOLOGY CENTER 1700			
in the above identified application. ✓ No additional fee is required. ✓ A check in the amount of is attached. ✓ The Assistant Commissioner is hereby authorized to charge and credit Deposit Account No. 09-0457(IBM) as described below. A duplicate copy of this sheet is enclosed. ✓ Charge the amount of ✓ Credit any overpayment. ✓ Charge any additional fee required.						
Jack P. Friedman Reg. No. 44,688	nedna- ature	Dated: 7/24/02				

Jack P. Friedman Reg. No. 44,688 Schmeiser, Olsen & Watts 3 Lear Jet Lane, Suite 201 Latham, NY 12110 (518) 220-1850

I certify that this document and fee is being deposited on 7/24/02 with the U.S. Postal Service as first class mail under 37 C.F.R. 1.8 and is addressed to the

first class mail under 37 C.F.R. 1.8 and is addressed to the Assistant Commissioner for Patents, Washington, D.C.

20231.

Signature of Person Mailing Correspondence

Kim Dwileski

Typed or Printed Name of Person Mailing Correspondence